

Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Current (Note 7)	Ipp	5	Α	8/20µs, Per Figure 3
ESD Protection – Contact Discharge	V _{ESD_Contact}	±8	kV	Standard IEC 61000-4-2
ESD Protection – Air Discharge	V _{ESD_Air}	±15	kV	Standard IEC 61000-4-2

Thermal Characteristics

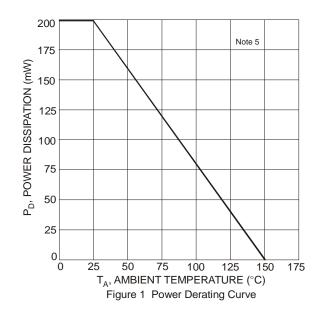
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	200	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-65 to +150	°C

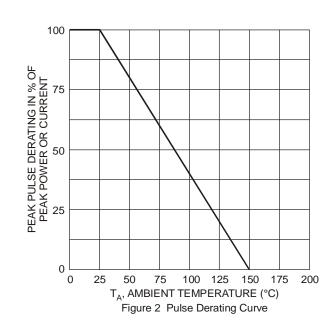
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic (Note 7)	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse working voltage	VRWM	-	-	3.3	V	-
Reverse current (Note 6)	I _R	-	0.1	1.0	μA	$V_R = V_{RWM} = 3.3V$
Reverse breakdown voltage	V _{BR}	6.0	-	-	V	I _R = 1mA
Forward voltage	V_{F}	0.6	0.8	0.95	V	$I_F = 8mA$
Reverse clamping voltage, Positive Transients	V _{CL1}	-	10.0	-	V	$I_{PP} = 1A, t_p = 8/20 \mu s$
Reverse clamping voltage, Negative Transients	V _{CL2}	-	-1.7	-	V	$I_{PP} = -1A$, $t_p = 8/20 \mu s$
Dynamic resistance	R _{DYN}	-	0.9	-	Ω	$I_R = 1A$, $t_p = 8/20 \mu s$
Capacitance	C _T	-	0.85	1.2	pF	$V_R = 1.65V, f = 1MHz$

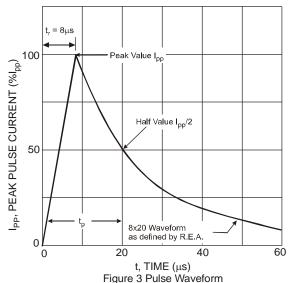
Notes:

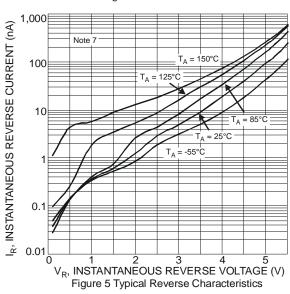
- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.
- 6. Short duration pulse test used to minimize self-heating effect.
- 7. Measured between any channel and GND.
- 8. For information on the impact of Diodes' USB 2.0 compatible ESD protectors on signal integrity including eye diagram plots, please refer to AN77 at the following URL: http://www.diodes.com/destools/appnote_dnote.html.

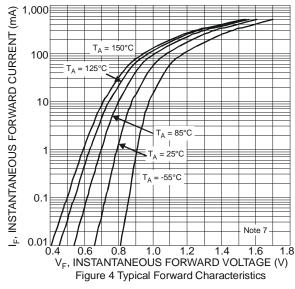


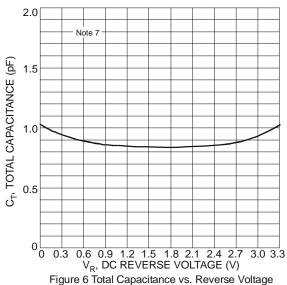






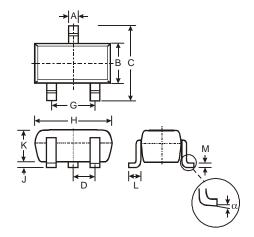






Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

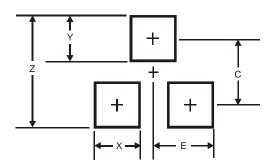


SOT323					
Dim	Min	Max	Тур		
Α	0.25	0.40	0.30		
В	1.15	1.35	1.30		
C	2.00	2.20	2.10		
D	-	-	0.65		
G	1.20	1.40	1.30		
H	1.80	2.20	2.15		
7	0.0	0.10	0.05		
K	0.90	1.00	1.00		
L	0.25	0.40	0.30		
M	0.10	0.18	0.11		
α	0°	8°	-		
All Dimensions in mm					



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.8
Х	0.7
Y	0.9
С	1.9
E	1.0

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